ETSI TS 103 713 V15.0.0 (2019-11)



Smart Secure Platform (SSP); SPI interface (Release 15) Reference
DTS/SCP-T103713vf00

Keywords
M2M, MFF

ETSI

650 Route des Lucioles F-06921 Sophia Antipolis Cedex - FRANCE

Tel.: +33 4 92 94 42 00 Fax: +33 4 93 65 47 16

Siret N° 348 623 562 00017 - NAF 742 C Association à but non lucratif enregistrée à la Sous-Préfecture de Grasse (06) N° 7803/88

Important notice

The present document can be downloaded from: <u>http://www.etsi.org/standards-search</u>

The present document may be made available in electronic versions and/or in print. The content of any electronic and/or print versions of the present document shall not be modified without the prior written authorization of ETSI. In case of any existing or perceived difference in contents between such versions and/or in print, the prevailing version of an ETSI deliverable is the one made publicly available in PDF format at www.etsi.org/deliver.

Users of the present document should be aware that the document may be subject to revision or change of status.

Information on the current status of this and other ETSI documents is available at https://portal.etsi.org/TB/ETSIDeliverableStatus.aspx

If you find errors in the present document, please send your comment to one of the following services: https://portal.etsi.org/People/CommitteeSupportStaff.aspx

Copyright Notification

No part may be reproduced or utilized in any form or by any means, electronic or mechanical, including photocopying and microfilm except as authorized by written permission of ETSI.

The content of the PDF version shall not be modified without the written authorization of ETSI.

The copyright and the foregoing restriction extend to reproduction in all media.

© ETSI 2019.

DECT™, **PLUGTESTS™**, **UMTS™** and the ETSI logo are trademarks of ETSI registered for the benefit of its Members. **3GPP™** and **LTE™** are trademarks of ETSI registered for the benefit of its Members and of the 3GPP Organizational Partners.

All rights reserved.

oneM2M[™] logo is a trademark of ETSI registered for the benefit of its Members and of the oneM2M Partners.

GSM® and the GSM logo are trademarks registered and owned by the GSM Association.

Contents

Intelle	ectual Property Rights	5
Forev	word	5
Moda	al verbs terminology	5
1	Scope	
1	•	
2	References	
2.1	Normative references	
2.2	Informative references.	6
3	Definition of terms, symbols and abbreviations	7
3.1	Terms	
3.2	Symbols	
3.3	Abbreviations	
4	Introduction	8
5	SCL Under-Layers Protocol Stack	
6	Electrical interfaces	
6.1	Introduction	
6.2	Physical interface with 5 signals	
6.3	Physical interface with 4 signals	
6.4	Electrical characteristics	
6.4.1	DC characteristics	11
6.4.2	Data transfer mode, AC characteristics	11
7	Data Link Layer	12
7.1	Overview	12
7.2	MAC Layer	12
7.2.1	Overview	
7.2.2	Timing	13
7.2.2.1	$\boldsymbol{\varepsilon}$	
7.2.2.2	,	
7.2.2.3	<u>.</u>	
7.2.3	5 signals MAC layer	
7.2.3.1		
7.2.3.2		
7.2.3.3 7.2.3.4		
7.2.3. ² 7.2.3.5		
7.2.3 7.2.4	4 signals MAC layer	
7.2.4 7.2.4.1	6 ,	
7.2.4.2		
7.2.4.3		
7.2.4.4		
7.2.4.5		
7.2.4.6		
7.2.4.7		
7.3	Link Layer Frame	
7.3.1	Overview	18
7.3.2	Frames generation and transfer rules	19
7.4	LLC layers	22
7.5	Interworking of the LLC layers	23
7.6	MCT LLC definition	
7.6.1	MCT LPDU structure	
7.6.2	MCT_DATA from master	
7.6.3	MCT_DATA from slave	
7.6.4	MCT activation procedure	26

7.7	SHDLC LLC defini	tion	26
7.7.1	SHDLC overvie	w	26
7.7.2	Endpoints		26
7.7.3	Flow control		27
7.7.3.1	Overview		27
7.7.3.2	Flow control	based on SHDLC	27
Annex A	(informative):	Change history	28
History.			29

Intellectual Property Rights

Essential patents

IPRs essential or potentially essential to normative deliverables may have been declared to ETSI. The information pertaining to these essential IPRs, if any, is publicly available for **ETSI members and non-members**, and can be found in ETSI SR 000 314: "Intellectual Property Rights (IPRs); Essential, or potentially Essential, IPRs notified to ETSI in respect of ETSI standards", which is available from the ETSI Secretariat. Latest updates are available on the ETSI Web server (https://ipr.etsi.org/).

Pursuant to the ETSI IPR Policy, no investigation, including IPR searches, has been carried out by ETSI. No guarantee can be given as to the existence of other IPRs not referenced in ETSI SR 000 314 (or the updates on the ETSI Web server) which are, or may be, or may become, essential to the present document.

Trademarks

The present document may include trademarks and/or tradenames which are asserted and/or registered by their owners. ETSI claims no ownership of these except for any which are indicated as being the property of ETSI, and conveys no right to use or reproduce any trademark and/or tradename. Mention of those trademarks in the present document does not constitute an endorsement by ETSI of products, services or organizations associated with those trademarks.

Foreword

This Technical Specification (TS) has been produced by ETSI Technical Committee Smart Card Platform (SCP).

The contents of the present document are subject to continuing work within TC SCP and may change following formal TC SCP approval. If TC SCP modifies the contents of the present document, it will then be republished by ETSI with an identifying change of release date and an increase in version number as follows:

Version x.y.z

where:

- x the first digit:
 - 0 early working draft;
 - 1 presented to TC SCP for information;
 - 2 presented to TC SCP for approval;
 - 3 or greater indicates TC SCP approved document under change control.
- y the second digit is incremented for all changes of substance, i.e. technical enhancements, corrections, updates, etc.
- z the third digit is incremented when editorial only changes have been incorporated in the document.

Modal verbs terminology

In the present document "shall", "shall not", "should", "should not", "may", "need not", "will", "will not", "can" and "cannot" are to be interpreted as described in clause 3.2 of the <u>ETSI Drafting Rules</u> (Verbal forms for the expression of provisions).

"must" and "must not" are NOT allowed in ETSI deliverables except when used in direct citation.

1 Scope

The present document describes the SPI interface for the communication of an SSP, as defined in ETSI TS 103 666-1 [1] using the SCL protocol.

2 References

2.1 Normative references

References are either specific (identified by date of publication and/or edition number or version number) or non-specific. For specific references, only the cited version applies. For non-specific references, the latest version of the referenced document (including any amendments) applies.

• In the case of a reference to a TC SCP document, a non-specific reference implicitly refers to the latest version of that document in the same Release as the present document.

Referenced documents which are not found to be publicly available in the expected location might be found at https://docbox.etsi.org/Reference/.

NOTE: While any hyperlinks included in this clause were valid at the time of publication, ETSI cannot guarantee their long term validity.

The following referenced documents are necessary for the application of the present document.

- [1] ETSI TS 103 666-1: "Smart Secure Platform (SSP); Part 1: General characteristics".
- [2] ETSI TS 102 613: "Smart Cards; UICC Contactless Front-end (CLF) Interface; Physical and data link layer characteristics".
- [3] ISO/IEC 13239: "Information Technology -- Telecommunications and information exchange between systems -- High-level Data Link Control (HDLC) procedures".

2.2 Informative references

References are either specific (identified by date of publication and/or edition number or version number) or non-specific. For specific references, only the cited version applies. For non-specific references, the latest version of the referenced document (including any amendments) applies.

• In the case of a reference to a TC SCP document, a non-specific reference implicitly refers to the latest version of that document in the same Release as the present document.

NOTE: While any hyperlinks included in this clause were valid at the time of publication, ETSI cannot guarantee their long term validity.

The following referenced documents are not necessary for the application of the present document but they assist the user with regard to a particular subject area.

[i.1] ETSI TR 102 216: "Smart cards; Vocabulary for Smart Card Platform specifications".

3 Definition of terms, symbols and abbreviations

3.1 Terms

For the purposes of the present document, the terms given in ETSI TR 102 216 [i.1] and the following apply:

data transfer: information exchange during an SPI access between the master and the slave with SPI_MISO driven by the slave and SPI_MOSI driven by the master while the master is toggling the SPI_CLK signal

flow control: mechanism part of the Data Link Layer that consists of methods applied by transmitter in order to send at any time a number of logical data units that can be accepted by receiver

frame: link layer data structure consisting of a prologue or frame header, payload and epilogue or trailer usually containing the CRC bytes

MAC access request: request from the slave to the master for a data transfer, i.e. a MAC phase initiated by the slave

MAC phase: initiation of a data transfer by the master and/or request for a data transfer by the slave

SPI access: SPI_NSS assertion by the master, if not already asserted in the MAC phase, followed by SPI_CLK start for transferring a certain number of bytes according to the SPI master configuration

NOTE: The number of bytes transferred during an SPI access is always the same in both directions on SPI_MISO and SPI_MOSI and is also referred to as access length.

window size: maximum number of logical data units that can be sent from transmitter to receiver without any link layer acknowledgements for any of these data units

window size slot: fixed space allocated by slave in the receive buffer for the logical data units used for windows size definition

NOTE: The length of a window size slot equals Data Link Layer MTU.

3.2 Symbols

Void.

3.3 Abbreviations

For the purposes of the present document, the following abbreviations apply:

AC Alternating Current **ACT** Activation **CLF** ContactLess Frontend **CMD** Command Clock Phase **CPHA** CPOL Clock Polarity Cyclic Redundancy Check CRC DC Direct Current DLL Data Link Layer **FIFO** First In, First Out IO Input/Output IOH High Output Current (Output current corresponding to VOH) IOL Low Output Current (Output current corresponding to VOL) Logical Link Control LLC **LPDU** Link Protocol Data Unit Medium Access Control MAC MAC aCTivation **MCT** Master Input Slave Output **MISO** MOSI Master Output Slave Input

MTU	Maximum Transmission Unit
NSD	Non-Significant Data
OD	Open Drain
RFU	Reserved for Future Use
SCL	SSP Common Layer
SHDLC	Simplified High Level Data Link Control
SPI	Serial Peripheral Interface
SSP	Smart Secure Platform
SWP	Single Wire Protocol
NOTE:	Defined in ETSI TS 102 613 [2].
VDD	Supply Voltage
VIH	High Input Voltage (Input Voltage for High Logic Level)
VIL	Low Input Voltage (Input Voltage for Low Logic Level)
VOH	High Output Voltage (Output Voltage for High Logic Level)
VOL	Low Output Voltage (Output Voltage for Low Logic Level)

4 Introduction

The Serial Peripheral Interface (SPI) is a serial synchronous full-duplex communication interface between a single master and one or more slaves present on the same SPI bus, each slave being selected at one time by a dedicated SPI_NSS signal. This clause defines the physical, MAC and data link layers for the SPI interface.

In this clause the terms master and slave refer respectively to the terms master SPI and slave SPI.

5 SCL Under-Layers Protocol Stack

Figure 5.1 illustrates the protocol stack below the SCL supporting the SPI interface.

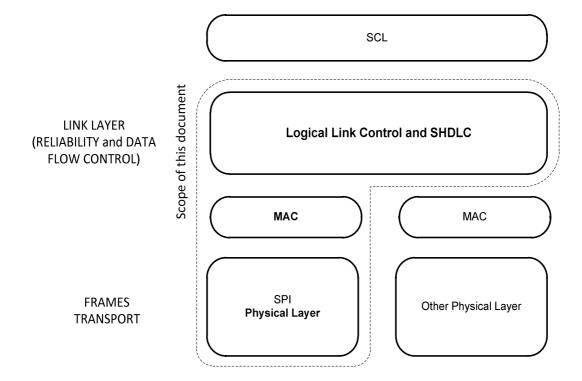


Figure 5.1: Protocol stack for SPI Interface

6 Electrical interfaces

6.1 Introduction

In the clauses below, different implementations of SPI interface are defined. These implementations allow bi-directional communication and the possibility for the slave to initiate communication with the master when it has data available thus avoiding the necessity for continuous polling to be performed by master.

Slave may initiate communication to send a command without a prior command from master.

6.2 Physical interface with 5 signals

Figure 6.1 illustrates the SPI electrical interface using 5 signals.

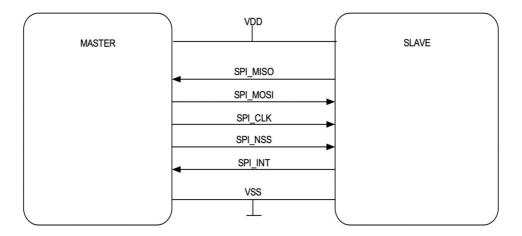


Figure 6.1: SPI electrical interface with 5 signals

This SPI interface describes two sets of signals:

- The generic and legacy SPI interface using the 4 signals: SPI_MOSI (Master Output Slave Input), SPI_MISO (Master Input Slave Output), SPI_CLK (clock) and the SPI_NSS signal used for the selection of a Slave Endpoint among N slaves sharing the same bus. SPI_MISO, SPI_MOSI and SPI_CLK can be shared between several SPI slaves present on the same SPI bus.
- The SPI_INT signal allows the slave to initiate a MAC access request in order to notify the master to start a data transfer.

SPI_INT signal is considered active or asserted at high voltage level.

SPI_NSS is considered active or asserted at low voltage level.

6.3 Physical interface with 4 signals

Figure 6.2 illustrates the SPI interface using 4 signals, bi-directional SPI_NSS.

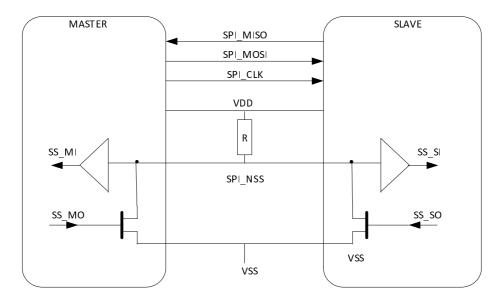


Figure 6.2: SPI electrical interface with 4 signals, bi-directional SPI_NSS

The SPI interface with 4 signals describes two sets of signals:

- The three generic and legacy SPI signals as SPI_MOSI (Master Output Slave Input), SPI_MISO (Master Input Slave Output) and SPI_CLK (clock). These signals can be shared between several SPI slaves as a bus.
- The SPI_NSS (Negative Slave Select) signal used for the selection of a slave endpoint among N slaves sharing the same bus and for the slave to initiate a MAC access request to notify the master to initiate a data transfer.

SPI_NSS is considered active or asserted at low voltage level. SPI_NSS requires a bidirectional IO implementing an Open Drain (OD) interface for both master and slave. This configuration allows driving the SPI_NSS signal to low voltage level by both master and slave without electrical contention.

A pull-up resistor allows to keep SPI_NSS at high state level (i.e. idle state) when SS_MO and SS_SO are not asserted. The SPI_NSS signal is at low state when either SS_MO or SS_SO are asserted.

NOTE: Despite the current industry de-facto SPI specification which defines SPI_NSS signal as unidirectional, driven by the master, in the present document the SPI_NSS in the 4 signals configuration is bidirectional.

Table 6.1: Definition of the signals

Signal	Description						
SS_MO	Internal master output signal for SPI_NSS assertion. SS_MO is at high state level for						
	generating a SPI_NSS signal assertion (i.e. low level state)						
SS_SO	Internal slave output signal for SPI_NSS assertion. SS_SO is at high state level for						
	enerating a SPI_NSS signal assertion (i.e. low level state)						
SS_MI	Internal master input signal indicating SPI_NSS status. SS_MI is at high state level when						
	the SPI_NSS signal is not asserted						
SS_SI	Internal slave input signal indicating SPI_NSS status. SS_SI is at high state level when						
	the SPI_NSS signal is not asserted						
SPI_NSS	SPI_NSS signal: low state level when asserted						

6.4 Electrical characteristics

6.4.1 DC characteristics

The SPI Electrical specification interface shall be defined for VDD operational voltage classes B and C as defined in ETSI TS 103 666-1 [1], clause 6.2.2.3.

Table 6.2: DC characteristics for operational voltage class B

Parameter	Symbol	Min	Max	Unit	Note/Test condition
Input high voltage	VIH	0,7 × VDD	VDD + 0,5	V	
Input low voltage	VIL	-0,5	0,3 × VDD	V	
Output high voltage	VOH	0,9 × VDD		V	IOH = -100 uA
Output low voltage	VOL		0,1 × VDD	V	IOL = 1,0 mA
SPI_NSS Low Level Output current (see note)	IOL	-1	-16	mA	VOL = 0,3 V
Maximal SPI_NSS line capacitance	CI	-	20	pF	
(see note)					
NOTE: Applicable for the physical i	nterface with	4 signals.			

Table 6.3: DC characteristics for operational voltage class C

Parameter	Symbol	Min	Max	Unit	Note/Test condition		
Input high voltage	VIH	0,7 × VDD	VDD + 0,3	V			
Input low voltage	VIL	-0,3	0,3 × VDD	V			
Output high voltage	VOH	0,9 × VDD		V	IOH = -100 uA		
Output low voltage	VOL		0,1 × VDD	V	IOL = 1,0 mA		
SPI_NSS Low Level Output current (see note)	IOL	-1	-10	mA	VOL = 0,3 V		
Maximal SPI_NSS line capacitance	CI	-	20	pF			
(see note)							
NOTE: Applicable for the physical interface with 4 signals.							

6.4.2 Data transfer mode, AC characteristics

The SPI interface shall implement the SPI mode 0 according to the industry de-facto SPI specification.

SPI mode 0 is determined by CPOL = 0 and CPHA = 0 where:

- CPOL: defines the SPI_CLK idle state.
- CPOL = 0 implies that the SPI_CLK is at input low voltage while it is idle.
- CPHA: defines the data sampling time.
- CPHA = 0 implies that data sampling is done on the rising edges of the SPI_CLK for both SPI_MISO and SPI_MOSI.

SPI_NSS is considered active or asserted at low voltage level.

Data availability timings with reference to SPI_CLK are shown in figure 6.3.

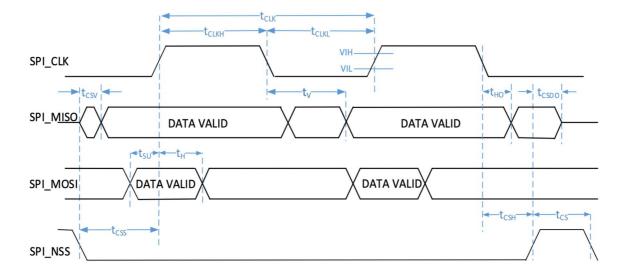


Figure 6.3: SPI timing diagram

Table 6.4: AC characteristics for 1,8 V and 3,3 V (SPI Slave, Mode 0: CPOL = 0 and CPHA = 0)

Symbol	Definition	Value
		(MIN values unless MAX specified)
fCLK	SPI_CLK frequency	Max SPI_CLK is specified by Slave at initialization in MCT_READY
tCLKL	SPI_CLK low time	0,45 x tCLK
tCLKH	SPI_CLK high time	0,45 x tCLK
tSU	Data setup time to clock rising edge	5 ns
tH	SPI_MOSI hold time/Data hold time to clock rising edge	3 ns
tHO	SPI_MISO hold time/Output hold time to clock falling edge	0 ns
tCSS	SPI_CS# setup time (1,8 V)	60 ns
tCSS	SPI_CS# setup time (3,3 V)	30 ns
tCSH	Hold time clock falling edge to SPI_CS# inactive	0,5 x tCLK
tCS	SPI_CS# inactive time (1,8 V)	60 ns
tCS	SPI_CS# inactive time (3,3 V)	30 ns
tCSV	SPI_MISO valid delay time from SPI_CS# active (1,8 V)	58 ns (MAX)
tCSV	SPI_MISO valid delay time from SPI_CS# active (3,3 V)	28 ns (MAX)
tV	SPI_MISO valid delay time from clock falling edge	0 ns (MIN) 0,7 × tCLKL (MAX)
tCSDO	SPI_MISO Output disable time from SPI_CS# inactive (1,8 V)	0 ns (MIN) 60 ns (MAX)
tCSDO	SPI_MISO Output disable time from SPI_CS# inactive (3,3 V)	0 ns (MIN) 30 ns (MAX)

7 Data Link Layer

7.1 Overview

Clause 9.1 in ETSI TS 102 613 [2] shall apply.

7.2 MAC Layer

7.2.1 Overview

The MAC phase is the initial handshake phase between SPI master and SPI slave followed by SPI data transfer phase.

7.2.2 Timing

7.2.2.1 Timing definitions

Table 7.1 describes the timing parameters of the MAC layer. In addition to these MAC timings, the timing requirements listed in AC electrical characteristics shall apply for all MAC diagrams in the following clauses.

Table 7.1: MAC timing parameters

Symbol	Definition	Value (min)/ Description Reference	
T1	Slave Ready Time	Reported in MCT_READY	MAC phase time prior to data transfer start. This time is needed for the SPI slave to be ready for the data transfer and is reported in MCT_READY.
T2	Slave Request Time	1 μs	SPI_NSS or SPI_IRQ assertion min pulse width.
Т3	Slave Resume Time from power saving mode	Reported in MCT_READY	Time from SPI_NSS assertion by master for slave resume to data transfer start. T3 value shall be used by master in MAC phase instead of T1 when the slave is in power saving mode.

7.2.2.2 T1 = Slave Ready Time

T1 is the MAC phase time required by the slave to get configured and enabled at the end of the MAC phase, ready for the data transfer phase start (i.e. when the SPI_CLK can be started by master).

T1 is defined from the leading edge of the SPI_NSS or SPI_INT assertion by either master or slave to the data transfer phase start.

The data transfer phase at the end of T1 is started by master by asserting SPI_NSS, if not already asserted depending on the prior MAC phase, followed by the SPI_CLK start.

T1 is slave implementation dependant

T1 is determined by the slave and includes T2 and any slave-specific internal latencies. Slave shall provide a T1 value that covers the worst–case time it needs between the moment of sampling SPI_NSS to the time when slave becomes ready for the data transfer.

Master shall allow at least the time T1 requested by slave between the start of the MAC phase initiated by either master or slave and the point in time when the data transfer phase starts. Master may use a higher value than T1, and it may vary T1 from one MAC phase to another.

7.2.2.3 T2 = Slave Request Time

T2 is the duration of an SPI_NSS or SPI_INT pulse generated by slave for a MAC access request.

The minimum value of T2 is 1 µs.

In order to sense the interrupts originating either from slave SPI_NSS or SPI_INT assertion, the master shall be configured for edge-triggered interrupts.

NOTE: The leading edges of the MAC access request signals of the slave should assert internal interrupt of the

7.2.2.4 T3 = Slave resume time from power saving mode

T3 is the slave resume time from power saving mode. It is slave implementation dependant. Slave reports at initialization in MCT_READY the minimum value of T3 required for slave to become ready for SPI access. Whenever master needs to resume the slave from power saving mode it should use during the MAC phase at least the time T3 instead of the MAC SLAVE_READY_TIME T1.

7.2.3 5 signals MAC layer

7.2.3.1 Initiation of the data transfer from the master

In this case at the start of a MAC phase master asserts the SPI_NSS and slave asserts the SPI_INT for making a MAC access request.

Figure 7.1 illustrates the initiation of the data transfer by the master.

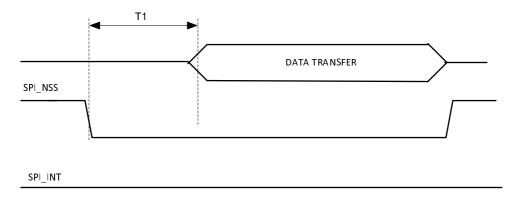


Figure 7.1: Initiation of the data transfer from the Master

The master shall run the following procedure:

- 1) Master asserts SPI_NSS then goes to the step 2.
- 2) Master waits for min T1 seconds then goes to the step 3. In use-cases when it is certain slave is not expected to initiate a MAC access request by SPI_INT assertion (e.g. at first access during SPI initialization) master may skip this step.
- 3) Master starts the bidirectional data transfer by toggling the SPI_CLK signal.
- 4) Master de-asserts SPI_NSS after data transfer completion i.e. SPI_CLK stopped.

7.2.3.2 Initiation of the data transfer from the slave

Figure 7.2 illustrates the initiation by slave of a MAC access request for a data transfer to be performed by the master.

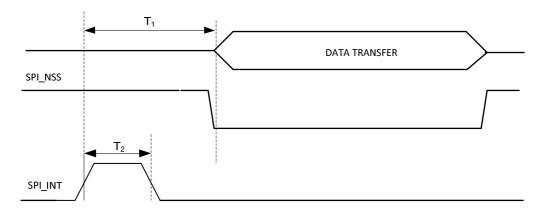


Figure 7.2: Initiation of the data transfer from the slave

The Slave runs the following procedure:

- I) If the SPI_NSS signal is at the high level state by reading SPI_NSS_SI then the slave goes to the step 2.
- 2) The Slave asserts SPI_INT by generating an SPI_INT pulse with a minimum width of T2 seconds then goes to the step 3. Master will generate an SPI access as a consequence of the SPI_INT assertion by slave.

- 3) Slave configures the SPI block and waits for data transfer from the master.
- 4) Master starts data transfer at a time greater than T1 following the leading edge of SPI_INT by asserting SPI_NSS and then starts SPI_CLK. At data transfer completion master enters step 5.
- 5) After data transfer completion and SPI_CLK stop, the master de-asserts SPI_NSS.

7.2.3.3 Simultaneous initiation of a data transfer from both master and slave

Figure 7.3 illustrates a simultaneous initiation from the master and the slave.

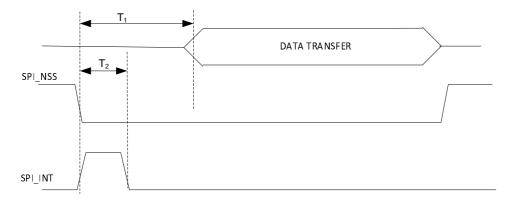


Figure 7.3: Simultaneous initiation of the data transfer from both master and slave

Both endpoints request a data transfer and run simultaneously their respective procedures. From the master perspective the resulting procedure is equivalent to the initiation from the master.

Slave makes a MAC access request by asserting SPI_INT according to the procedure described in clause 7.2.3.2 and waits for master to generate the access for data transfer.

The gap time T1 - T2 shall be long enough for the slave to prepare the SPI block for the data transfer.

7.2.3.4 MAC activation

The MAC activation procedure shall be the following if the SPI bus is not shared with other peripheral:

- The master shall set the SPI_MOSI to high impedance and the SPI_CLK at the low state level. Master SPI_NSS output shall be set to high impedance.
- The master shall drive the VDD power line ON.

7.2.3.5 MAC deactivation

The MAC deactivation procedure shall be the following if the SPI bus is not shared with other peripheral:

- The master shall set the SPI_MOSI to high impedance and the SPI_CLK at the low state level. Master SPI_NSS output shall be set to high impedance.
- The master shall drive the VDD power line OFF.

7.2.4 4 signals MAC layer

7.2.4.1 Introduction

Considering a slave SPI block is normally always enabled to be ready for an access from master when selected by SPI_NSS assertion, before a slave asserts SPI_NSS for a MAC access request it shall disable its SPI block. This is necessary in order to avoid self-selection e.g. driving MISO in contention with MISO signals of other slaves potentially selected at the same time on the same bus.

7.2.4.2 Initiation of the data transfer from the master

Figure 7.4 illustrates the initiation of the data transfer by the master.

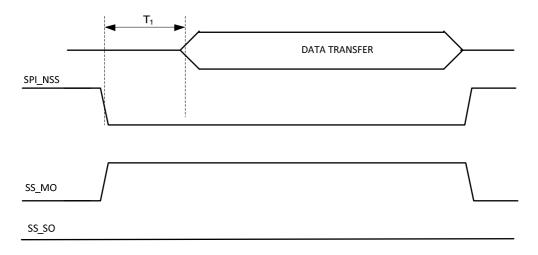


Figure 7.4: Initiation of the data transfer from the master

The Master shall perform the following procedure:

- 1) The master checks if the SPI_NSS signal is at the high state level by reading SS_MI then goes to the step 2 otherwise loops on the step 1.
- 2) The master asserts SS_MO (to drive SPI_NSS signal to the low state) then goes to the step 3.
- 3) The master waits for T1 seconds then goes to the step 4. If master is certain that slave will not initiate a MAC access request by asserting SPI_NSS then master may skip this step.
- 4) The master starts the bidirectional data transfer by toggling the SPI_CLK signal.
- 5) After data transfer completion i.e. SPI_CLK stop, master de-asserts SPI_NSS.

7.2.4.3 Initiation of the data transfer from the slave

Figure 7.5 illustrates the initiation of the data transfer from slave.

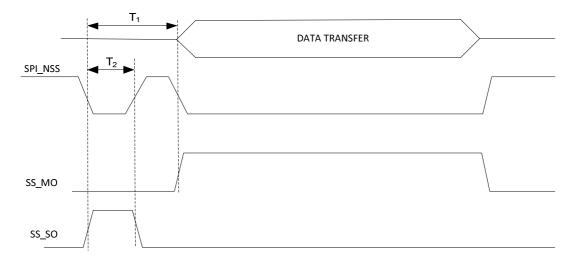


Figure 7.5: Slave initiates a MAC access request

The slave runs the following procedure:

1) If the SPI_NSS signal is found at the high level state by reading SS_SI then the slave goes to the step 2.

- 2) The slave disables its SPI cell then goes to the step 3.
- 3) The slave asserts SS_SO to drive SPI_NSS to the low level state for at least T2 seconds then goes to step 4.
- 4) The slave enables its SPI Interface and waits for master to initiate the data transfer.
- 5) The SS_MI signal generates an internal interrupt for the master, triggered on SPI_NSS falling edge. This interrupt initiates a data transfer procedure: master asserts SS_MO after at least T1 following the SPI_NSS assertion by the slave for the MAC access request.
- 6) SPI CLK starts after the SPI NSS assertion by the master in the previous step, data transfer is performed.
- 7) After data transfer completion i.e. SPI_CLK stop, master de-asserts SPI_NSS.

7.2.4.4 Simultaneous initiation of the data transfer from both master and slave

Figure 7.6 illustrates a simultaneous initiation from the master and the slave.

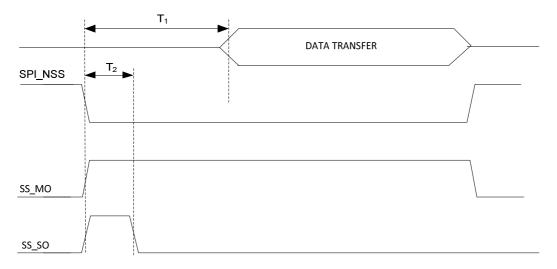


Figure 7.6: Simultaneous initiation of the data transfer from both master and slave

Both endpoints initiate a MAC phase for data transfers and run simultaneously their respective procedures. From a master perspective the resulting procedure is equivalent to the initiation from the master. Slave initiates a MAC access request and waits for the access start from master as per the timings defined. The time T1 - T2 shall be long enough for the slave to enable the SPI block.

7.2.4.5 Slave-driven Flow Control

In certain use-cases and depending on the SPI block design, a slave may assert SS_SO during a data transfer in progress for flow control e.g. when slave needs to delay a subsequent master access as slave estimates it may not be ready for handling receive and transmit FIFO data due to unforeseen events. It is assumed slave already prepared data to be sent (if available) for the current data transfer before it started and the transfer completes normally. Such an assertion of SS_SO while the master access is in progress is not a slave MAC access request and a slave frame shall not start (MISO) in the middle of the current access, a frame shall be always aligned with the start of an access.

Irrespective of the MAC procedures defined the slave may assert the SPI_NSS signal after the start of the data transfer, by asserting SS_SO for maintaining SPI_NSS asserted despite the SPI_NSS de-assertion by the master. As long as the SPI_NSS signal is asserted and even if the data transfer is completed, the master cannot run the MAC initiation by the master procedure as defined in the clause 7.2.4.1.

Slave may assert SS_SO for flow control any time between the start of the master access for data transfer by SPI_NSS assertion and the end of the data transfer i.e. before SPI_NSS de-assertion by master.

NOTE: Detection by the slave of a data transfer start for initiating flow control could be performed either by sensing the assertion of the SPI_NSS by master or by detection of the first bytes transferred.

Figure 7.7 illustrates the waveforms for this procedure.

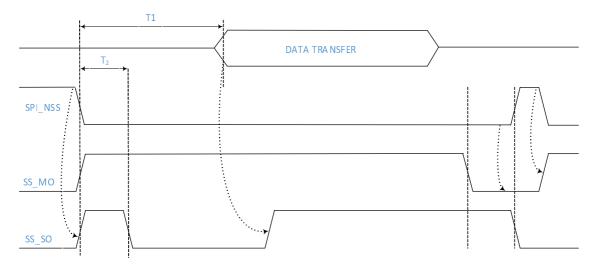


Figure 7.7: Slave activates hardware flow control by assertion of SS_SO

7.2.4.6 MAC activation

The MAC activation procedure shall be the following if the SPI bus is not shared with other peripheral:

- The master shall set the SPI_MOSI to high impedance and the SPI_CLK at the low state level. The SS_MO shall be at the low level then driving the SPI_NSS output to high impedance.
- The master shall drive the VDD power line ON.

7.2.4.7 MAC deactivation

The MAC deactivation procedure shall be the following if the SPI bus is not shared with other peripheral:

- The master shall set the SPI_MOSI to high impedance and the SPI_CLK at the low state level. The SS_MO shall be at the low level then driving the SPI_NSS output to high impedance.
- The master shall drive the VDD power line OFF.

7.3 Link Layer Frame

7.3.1 Overview

Master and slave exchange frames. The format of the frames generated by master and slave is determined by the link layer and it is shown in figure 7.8.

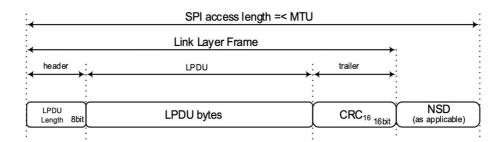


Figure 7.8: Link Layer Frame structure

All bytes shall be transmitted with MSB first (most significant bit first). All fields of the frame are transferred with the most significant byte first.

The link layer frame shall contain the following fields:

- LPDU length: length of the LPDU, 1 byte.
- LPDU (Link Protocol Data Unit): LPDU includes the LLC control byte as defined in clause 7.4.
- CRC informs about the integrity of the whole frame i.e. Length and LPDU. Detection of errors in a frame shall be based on the 16-bit frame checking sequence as given in ISO/IEC 13239 [3]. The CRC polynomial is: X16 +X12 + X5 + 1. Its initial value is 'FFFF'.

Link Layer Frames are exchanged between SPI master and slave during SPI accesses. The SPI master determines the number of bytes exchanged in an SPI access. The maximum length of an access is MTU.

Link Layer frames (including header, LPDU and trailer) shall always be prepared with length less than or equal to MTU.

MTU values are negotiated at SPI interface initialization as described in clause 7.6. The resultant MTU shall be the smallest MTU value between the MTU of the master and the MTU of the slave. The MTU shall be the same irrespective of the transfer direction.

Non-significant data (NSD) may be appended at the end of a master or slave link layer frame until the end of the SPI access according to the rules described below, considering LPDU Length + 3 + NSD length $\leq \text{MTU}$.

NSD shall consist of idle bytes set to the value 'FF' sent by:

- A master while retrieving a slave frame and not sending any frame.
- A slave while receiving a frame from master and not sending any frame.

Master frames, slave frames or remaining bytes of a slave frame (i.e. in a second SPI access for retrieving a slave frame) shall always start aligned on the first bytes transmitted on SPI_MOSI and SPI_MISO at SPI_CLK start.

The LPDU Length value shall be compliant with the values indicated in the table 7.2.

Master frames, slave frames or remaining bytes of a slave frame (i.e. in a second SPI access for retrieving a slave frame) shall always start aligned on the first bytes transmitted on SPI_MOSI and SPI_MISO at SPI_CLK start.

The LPDU Length value shall be compliant with the values indicated in the table 7.2.

Table 7.2

LPDU Length	LPDU
'00'	RFU
'01' to '1D'	With MTU = 32
'01' to '3D'	With MTU = 64
'01' to '7D'	With MTU = 128
'01' to 'FD'	With MTU = 256
'FE'	RFU
'FF'	Forbidden (The link layer frame is not present and only NSD bytes are present)

7.3.2 Frames generation and transfer rules

The SPI master initiates an SPI access either to send a frame, retrieve a frame from the slave after a MAC access request or both.

If the SPI master has a frame to send, the SPI master shall send that frame in a single SPI access, however the SPI master may initiate a SPI access with a length higher than the length of the frame to send.

In case the SPI access is longer than the length of the frame being send, SPI master and/or slave shall add non-significant data (NSD) bytes following the CRC until the end of the SPI access.

A slave frame shall be retrieved in at most two SPI accesses if the number of bytes of the first SPI access is shorter than the slave frame. If the SPI master did not receive the entire slave frame in one SPI access, the master shall initiate a second SPI access with a length equal or greater than the number of remaining bytes of the slave frame to be retrieved from the slave.

In the second SPI access, the slave shall continue to send the same frame from the point where the previous SPI access stopped. The remaining part of a slave frame retrieved in a second access shall start on the first byte of the second access with the byte following the last byte retrieved in the prior access.

Master shall send only NSD bytes (i.e. bytes set to the value 'FF') during the second SPI access for retrieving the remaining bytes of a slave frame.

To retrieve a slave frame the SPI master may proceed with the following steps:

- When master does not have a frame to send and slave initiates a MAC access request asking for data transfer:
 - Step 1: master may generate an SPI access of minimum 1 byte to retrieve the slave frame length information.
 - Step 2: if the slave frame has not been entirely received in the first SPI access, the SPI master shall generate a second SPI access for retrieving the remaining bytes of the slave frame based on the information on the slave frame length received in the slave frame header during the first access.
- When master has a frame to send:
 - Step 1: master generates an SPI access with the length equal or higher than its frame length. At the same time master may receive on SPI_MISO part of or a full slave frame. When SPI access length is greater than the slave frame length, the slave sends NSD bytes at the end of its link layer frame, following the CRC bytes.
 - Step 2: if SPI access length is less than slave frame length, master shall generate a second SPI access for retrieving the remaining bytes of the slave frame based on the information on the slave frame length received in the slave frame header during the first SPI access.

In both cases above, master may generate a first SPI access with the length based on estimated optimal length for slave frame retrieval or may generate an SPI access of maximum length i.e. MTU in order to transfer the full slave frame during one SPI access.

The length byte of any frame shall always be the first byte sent in an SPI access, i.e. a new frame shall not be started in the same SPI access.

7.3.3 Data transfer cases

Some of the most representative data transfer cases based on the frames generation and transfer rules in clause 7.3.2 are described below. Any frame sent by master or slave shall be preceded by a MAC phase issued respectively by the master or slave. When two accesses are required for transferring a slave frame, master shall generate the second access at any time greater than or equal to the tCS value in clause 6.4.2.

Case 1: master initiates the MAC phase and then sends a frame. SPI access length is determined by the master frame length. No data is received from the slave.

SPI_MOSI	MAC	LEN	LEN LPDU CRC				
SPI_MISO	NO MAC		NSD				
		(SPI access Length =< MTU	\longrightarrow			

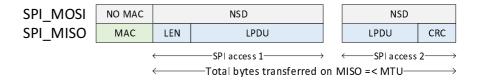
Case 2: slave initiates a slave MAC access request to transfer a frame. Master performs a first access to retrieve the slave frame length followed by a second access to retrieve the remaining bytes of the slave frame considering the length information from the first access.

SPI_MOSI	NO MAC	NSD	NSD	
SPI_MISO	MAC	LEN	LPDU	C RC
			—Total bytes transferred on MISO =< MTU—	\longrightarrow

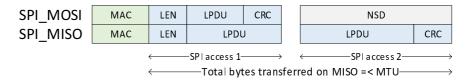
Case 3: slave initiates a MAC access request for sending a frame. Master generates an access with length equal to MTU to make sure the slave frame is transferred in a single access. Slave frame is shorter than the access length and slave appends NSD bytes after the end of its frame until the end of the access.



Case 4: slave initiates a slave MAC access request for sending a frame. Consequently, master generates an access with length based on a best estimate. Master retrieves only part of the frame during the first access and will generate a second access to retrieve the remaining bytes of the slave frame. The length of the second access is based on the frame length information retrieved in the prior access. The total number of bytes transferred on MISO over both accesses is less than or equal to the MTU.



Case 5: both master and slave have frames to transfer and MAC phase is initiated by both simultaneously. Master generates an access with length determined by its frame length. Master finds out that only a part of a slave frame was received and generates a second access to retrieve the remaining bytes of the slave frame.



Case 6: both master and slave have frames to transfer and both initiate the MAC phase simultaneously. Master generates an access with length determined by its frame length. As the slave frame is shorter than the master frame, slave adds NSD bytes after the end of its frame up to access end.

SPI_MOSI	MAC LEN LPDU							
SPI_MISO	MAC	LEN	LPDU CRC NS					
← SPI access ength =< MTU								

Case 7: both master and slave have frames to transfer and both initiate the MAC phase simultaneously. Master generates an access with the length equal to MTU to receive any slave frame occurring at the same time within a single access. Both master and slave may append NSD bytes after the end of their frames, up to access completion.

SPI_MOSI	MAC	LEN	LPDU			CRC	NSD
SPI_MISO	МАС	LEN	LPDU	CRC		NSD	
			SPI access len	gth = M	Γυ		\longrightarrow

The green boxes in the figures above indicate the initiator(s) of the MAC phase.

7.4 LLC layers

Three Logical Link Control (LLC) layers are defined in the present document:

- SHDLC: this is the generic LLC. SHDLC is defined in ETSI TS 102 613 [2], clause 10. Support of this LLC is mandatory for the master and the slave.
- CLT: this LLC is used for some proprietary protocol handling. CLT mode is defined in ETSI TS 102 613 [2], clause 11. Support of this LLC is optional for the master and the slave.
- MCT: this LLC consist of frames used during interface activation. Support of this LLC is mandatory for the
 master and the slave.

The control field is the first byte of the LPDU. Definition for the different LLC layers can be found in table 7.3.

Frame types Bit field 8 7 6 2 0 0 0 All settings **MCT** 0 0 1 MCT type ACT (not used) 0 1 1 CLT CMD 0 0 SHDLC All settings

Table 7.3: LLC control field coding

The LPDUs shall be structured according to figures 7.9, 7.10 or 7.11, depending on the frame type.

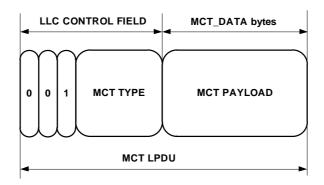


Figure 7.9: LPDU structure of the LLC layer of type MCT

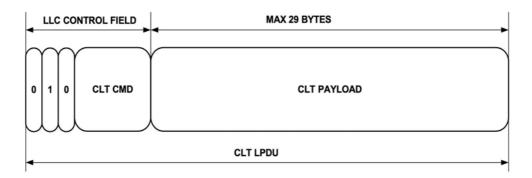


Figure 7.10: LPDU structure of the LLC layer of type CLT

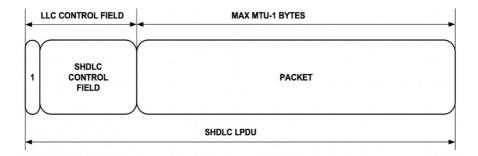


Figure 7.11: LPDU structure of the LLC layer of type SHDLC

7.5 Interworking of the LLC layers

After MAC activation, the SHDLC link shall not be established and no CLT session shall be open. Only the MCT LLC shall be used by the master and by the slave for the SPI interface initialization.

The master shall take the following action after a successful MCT LLC phase:

- If the master has data to be sent to the slave (e.g. due to a contactless transaction) that requires the use of the CLT LLC, it shall initiate a CLT LLC session.
- Otherwise it shall start the establishment of an SHDLC link as soon as possible.

After the slave and the master have established the SHDLC link or opened the CLT session, the slave and the master shall not send MCT LLC frames; received MCT LLC frames shall be ignored.

To enter the SHDLC LLC for the first time after MCT LLC, the link establishment procedure as described in clause 7.4 shall apply.

Once the SHDLC link is established, a CLT session shall not invalidate the SHDLC context and the endpoint capabilities negotiated during the SHDLC link establishment.

To enter the CLT LLC from MCT LLC or SHDLC LLC, the CLT session shall be opened as described in clause 11.6 of ETSI TS 102 613 [2]. The master shall open a CLT session only when all SHDLC I-Frames are acknowledged. SHDLC LLC frames received by the slave or by the master during a CLT session close the CLT session.

In case the slave or the master receives a corrupted frame, then the receiving entity shall use the error recovery procedure defined for the LLC of the last correctly received frame. Immediately after MAC activation, the error handling of the MCT LLC shall apply.

LPDU may be the SCL packet as defined in ETSI TS 103 666-1 [1], clause 8.3.2.

7.6 MCT LLC definition

7.6.1 MCT LPDU structure

The MCT LPDU shall be structured according to figure 7.12.

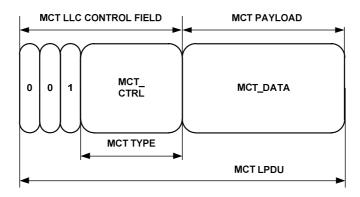


Figure 7.12: MCT LPDU structure

The meaning of MCT_CTRL and MCT_DATA is given in table 7.4.

Table 7.4: Meaning of MCT_CTRL and MCT_DATA

MCT_CTRL	Meaning	MCT_DATA				
000	MCT_READY Sent from Slave to Master	See table 7.5				
010	MCT_MASTER_REQ Sent from Master to Slave	See table 7.7				
All other values (see note)	RFU					
NOTE: All other values are reserved for future use. These values shall not be set by the transmitting entity and shall be ignored by the receiving entity.						

7.6.2 MCT_DATA from master

Tables 7.5, 7.6 and 7.7 define the capabilities of the master.

Table 7.5: Master-specific MCT_DATA field

Byte	Info/parameter	Meaning
0	Spec_Ver	Specification version to which master is compliant. Defined in table 7.6.
1	Capabilities	Defined in table 7.7.
2,3	Т4	Inactivity period for power saving mode (ms). 'FFFF' value mandates slave to not enter power saving mode based on elapsed inactivity period, therefore slave shall answer with the same value.

Table 7.6: Specification version

Bit field	Value	Meaning
8 to 4	00001	Major version of the SPI interface
3 to 1	000	Minor version of the SPI interface

Table 7.7: Master capabilities indication in MCT_DATA field

Bit field	Value	Meaning			
8 to 6	000	RFU (see note)			
5, 4	11	Full Power Mode 3 supported			
	10	Full Power Mode 2 supported			
	01	Full Power Mode 1 e.g. 10 mA supported			
	00	Low Power Mode e.g. 5 mA supported			
	11	MTU 256 bytes			
3, 2	10	MTU 128 bytes			
3, 2	01	MTU 64 bytes			
	00	MTU 32 bytes			
1	1	RFU			
0		Flow control SHDLC-based (default)			
NOTE: The	ese bits shall not be set by the master and shall be ignored by				
the	the slave.				

After the SPI activation as defined in the clause 7.2.3.4 or in the clause 7.2.4.6, the master shall send the MCT_MASTER_REQ frame and the slave shall respond with the MCT_READY frame.

The MCT phase shall be performed with default SPI_CLK = 1MHz and T1 \geq 255 μ s. Slave shall start in Low Power Mode following VDD ON, it may switch to a Full Power mode depending on the power mode capabilities received from the master in MCT_MASTER_REQ.

The MTU negotiation between the master and slave shall be between the MTU sent by the master in the MCT_MASTER_REQ frame and the MTU sent by the slave in the MCT_READY. The lower of the MTU values will be used by both master and slave for all frames.

Master indicates in MCT_MASTER_REQ its power source availability (i.e. Low Power, Full Power Mode 1, Full Power Mode 2 or Full Power Mode 3). Slave shall support at least Low Power Mode and Full Power Mode 1 and shall be able to limit its maximum current according to power source capabilities.

7.6.3 MCT DATA from slave

Tables 7.8. and 7.9 define the capabilities of the slave.

Table 7.8: Slave-specific MCT_DATA field (bytes 0...7)

Byte	Info/parameter	Meaning			
0	Spec_Ver	Specification version to which slave is compliant. Defined in table 7.6.			
1	Capabilities	Defined in table 7.9.			
2	SPI_CLK	Max SPI_CLK value supported by SPI slave (MHz).			
3	T1	Slave MAC Ready Time (µs).			
4	T3	Slave resume time from power saving mode (us) (see note 1).			
5,6	T4	Slave supported Inactivity period for entering power saving mode T4 (ms). 'FFFF' means slave will not enter power saving mode based on elapsed inactivity period.			
7	POT	Power-ON Time: time after slave VDD valid when master can send MCT_MASTER_REQ (ms) (see note 2).			
NOTE 1: In case a slave may "self-resume" (e.g. due to activities on another interface) and it has T3 < T1 slave shall report T1 value for T3.					

Table 7.9: Slave capabilities indication in MCT_DATA field byte 0

Bit field	Value	Meaning			
8 to 4	00000	RFU (see note)			
	11	MTU 256 bytes			
2.0	10	MTU 128 bytes			
3, 2	01	MTU 64 bytes			
	00	MTU 32 bytes			
. 1		RFU			
l .	0	Flow control SHDLC-based (default)			
NOTE:	These bits shall not be set by the slave and shall be ignored by				
1	the master.				

7.6.4 MCT activation procedure

Slave start-up time following power-on is defined as POT and has an initial value of 1 s. After POT time (from the time VDD is valid after power-on) slave shall be ready to receive the MCT_MASTER_REQ from master. Shorter POT values may be reported by slave in MCT_READY. Master shall use the POT value reported by slave or a higher value in subsequent power-up sequences.

Master shall wait for MCT_READY from slave after sending MCT_MASTER_REQ. In case slave did not send MCT_READY response (no MAC access request) within MCT_SLAVE_TIMEOUT or if MCT_READY is corrupted, master shall retry the MCT activation by sending another MCT_MASTER_REQ frame. Master shall retry at least two times i.e. shall re-send MCT_MASTER_REQ at least twice without power toggle. Specific recovery procedure further steps after these retries are implementation specific and out-of-scope of the present document.

After power-up, if slave gets a corrupted frame or any other frame instead of the MCT_MASTER_REQ, slave shall discard the data and remain in receive state. If slave receives three corrupted or invalid frames instead of MCT_MASTER_REQ, slave should enter power saving mode. If the MCT activation has not been successfully performed or master did not initiate an SPI access within MCT_MASTER_TIMEOUT following power-on or for the subsequent retries in case of errors, slave should enter power saving mode.

MCT_MASTER_TIMEOUT is the maximum time within which the master shall send the MCT_MASTER_REQ after power-on or for the retries in case of errors. The value defined is 1 s.

MCT_SLAVE_TIMEOUT is the maximum time within which the slave shall send the MCT_READY response to MCT_MASTER_REQ. The default value defined is 200 ms. A slave may send MCT_READY faster according to certain applications requirements.

7.7 SHDLC LLC definition

7.7.1 SHDLC overview

The provisions of ETSI TS 102 613 [2], clause 10.1 shall apply. The SWP SHDLC layer is replaced by the SPI SHDLC layer defined in the present document.

The SHDLC layer shall ensure that data passed up to the next layer has been received exactly as transmitted i.e. error free, without loss and in the correct order. Also, the SHDLC layer manages the flow control, which ensures that data is transmitted only as fast as the receiver may receive it.

The provisions of ETSI TS 102 613 [2] clauses from 10.3 to 10.8 shall apply. Additional SHDLC rules are defined below.

7.7.2 Endpoints

SHDLC communication occurs between two endpoints. Those endpoints may be either the master endpoint or the slave endpoint. There is no priority of traffic.

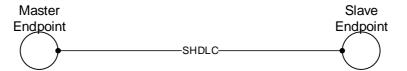


Figure 7.13: Endpoints

In ETSI TS 102 613 [2], clause 10, the term CLF refers to the master endpoint and the term UICC to the slave endpoint.

7.7.3 Flow control

7.7.3.1 Overview

Flow control is performed by a transmitter in order to avoid corruption or loss of data. It consists of methods applied by the transmitter and receiver in order to send a maximum number of SHDLC frames that can be accepted by the receiver, after which it shall stop sending data until the receiver sends at least an acknowledgement (e.g. SHDLC I-frame or SHDLC S-frame) for one of the received SHDLC frames.

7.7.3.2 Flow control based on SHDLC

The method defined in this clause is based on SHDLC flow control, as defined in ETSI TS 102 613 [2].

In addition to the provisions of clause 7.3.2, the total number of bytes transferred on SPI_MOSI while retrieving a slave frame over 2 accesses shall be less than the maximum slave frame length i.e. MTU or a Window Size slot depth.

NOTE: The number of free Window Size slots is not to be decremented for the second access for retrieving the remaining bytes of a slave frame.

The maximum number of SHDLC frames that can be sent by a transmitter is determined by the negotiated Window Size.

Annex A (informative): Change history

The table below indicates all changes that have been incorporated into the present document since it was placed under change control.

Change history								
Date	Meeting	Plenary Doc	CR	Rev	Cat	Subject/Comment	Old	New
	TEC#81					First draft based on ETSI TS 103 666-1 V0.12.0		0.12.0
	TEC#81					SCPTEC(19)000180r1		0.13.0
						SCPTEC(19)000188r2		
						SCPTEC(19)000189		
						SCPTEC(19)000190r2		
						SCPTEC(19)000191r2		
						SCPTEC(19)000218r1		
	TEC#82					SCPTEC(19)000264r2		0.15.0
						SCPTEC(19)000265r2		
						SCPTEC(19)000266r1		
						SCPTEC(19)000267r2		
						SCPTEC(19)000281r1		
						SCPTEC(19)000287r1		

History

	Document history						
V15.0.0	November 2019	Publication					